

CMPFJ175
 CMPFJ176
 CMPFJ177

**SURFACE MOUNT SILICON
 P-CHANNEL JFETS**



www.centrasemi.com



SOT-23 CASE

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPFJ175, CMPFJ176, and CMPFJ177 are epoxy molded P-Channel JFETs manufactured in an SOT-23 case, designed for low level amplifier applications.

MARKING CODES: CMPFJ175: 6W

CMPFJ176: 6X

CMPFJ177: 6Y

MAXIMUM RATINGS: ($T_A=25^\circ\text{C}$)

Gate-Drain Voltage
 Gate-Source Voltage
 Gate Current
 Power Dissipation
 Operating and Storage Junction Temperature
 Thermal Resistance

SYMBOL

V_{GD}
 V_{GS}
 I_G
 P_D
 T_J, T_{stg}
 Θ_{JA}

UNITS

V
 V
 mA
 mW
 $^\circ\text{C}$
 $^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS: ($T_A=25^\circ\text{C}$ unless otherwise noted)

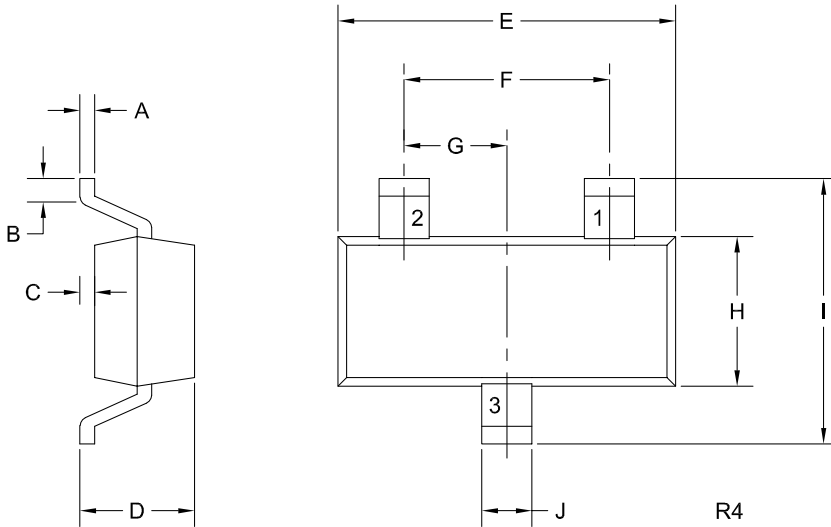
SYMBOL	TEST CONDITIONS	CMPFJ175		CMPFJ176		CMPFJ177		UNITS
		MIN	MAX	MIN	MAX	MIN	MAX	
I_{GSS}	$V_{GS}=20\text{V}$	-	1.0	-	1.0	-	1.0	nA
I_{DSS}	$V_{DS}=15\text{V}$	7.0	60	2.0	25	1.5	20	mA
BV_{GSS}	$I_G=1.0\mu\text{A}$	30	-	30	-	30	-	V
$V_{GS(off)}$	$V_{DS}=15\text{V}, I_D=10\text{nA}$	3.0	6.0	1.0	4.0	0.8	2.5	V
$r_{DS(ON)}$	$V_{DS}=0.1\text{V}$	-	125	-	250	-	300	Ω

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SOT-23 CASE - MECHANICAL OUTLINE



LEAD CODE:

- 1) Drain
- 2) Source
- 3) Gate

MARKING CODES:

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CMPFJ177: 6Y

DIMENSIONS				
SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.003	0.007	0.08	0.18
B	0.006	-	0.15	-
C	-	0.005	-	0.13
D	0.035	0.044	0.89	1.12
E	0.110	0.120	2.80	3.05
F	0.075		1.90	
G	0.037		0.95	
H	0.047	0.055	1.19	1.40
I	0.083	0.104	2.10	2.64
J	0.014	0.020	0.35	0.50

SOT-23 (REV: R4)

R5 (08-June 2023)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp.
145 Adams Avenue
Hauppauge, NY 11788 USA
Main Tel: (631) 435-1110
Main Fax: (631) 435-1824
Support Team Fax: (631) 435-3388
www.centrasemi.com

Worldwide Field Representatives:
www.centrasemi.com/wwreps

Worldwide Distributors:
www.centrasemi.com/wwdistributors

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